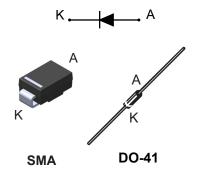


# 1000 V - 1 A high efficiency ultrafast diode



#### **Features**

- · Low forwarded voltage drop
- · High reliability
- · High surge current capability
- · Soft switching for reduced EMI disturbances
- Planar technology
- ECOPACK2 compliant

### **Applications**

- · Switching diode
- · Auxiliary power supply

### **Description**

The STTH110, which is using ST ultrafast high voltage planar technology, is especially suited for free-wheeling, clamping, snubbering, demagnetization in power supplies and other power switching applications.

Product status
STTH110

Product summary					
Symbol	Value				
I <sub>F(AV)</sub>	1 A				
V <sub>RRM</sub>	1000 V				
T <sub>j(max.)</sub>	175 °C				
$V_{F(typ.)}$	1.42 V				



### 1 Characteristics

Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified)

Symbol	Parameter	Value	Unit		
$V_{RRM}$	Repetitive peak reverse voltage	1000	V		
V <sub>RMS</sub>	Voltage rms			700	V
			T <sub>L</sub> = 125 °C		
IF(AV)	$I_{F(AV)}$ Average forward current $\delta$ = 0.5, square wave	DO-41	T <sub>L</sub> = 100 °C		Α
	SMA		t = 0.2 ma sinussidal	18	
I <sub>FSM</sub>	Surge non repetitive forward current $t_p = 8.3 \text{ ms sinusoidal}$			20	Α
T <sub>stg</sub>	Storage temperature range	-50 to +175	°C		
T <sub>j</sub>	Maximum operating junction temperature	+175	°C		

Table 2. Thermal resistance parameter

Symbol		Max. value	Unit		
P., a.s.	Junction to lead		SMA	30	
R <sub>th(j-l)</sub>	Junction to lead	Lood longth = 10 mm	DO-41	45	°C/W
R <sub>th(j-a)</sub>	Junction to ambient	Lead length = 10 mm	DO-41	110	

For more information, please refer to the following application note:

• AN5088 : Rectifiers thermal management, handling and mounting recommendations

Table 3. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I <sub>R</sub> <sup>(1)</sup>	Deverse leakage current	T <sub>j</sub> = 25 °C	V <sub>R</sub> = 1000 V	-		10	μА
IR <sup>(1)</sup> Reverse lea	Reverse leakage current	T <sub>j</sub> = 125 °C		-		50	
V <sub>F</sub> <sup>(2)</sup> Forward voltage drop		T <sub>j</sub> = 25 °C	I <sub>E</sub> = 1 A	-		1.7	V
VF <sup>(2)</sup>	Forward voltage drop	T <sub>j</sub> = 150 °C	IF = I A	-	0.98	1.42	V

- 1. Pulse test:  $t_p$  = 5 ms,  $\delta$  < 2%
- 2. Pulse test:  $t_p$  = 380  $\mu$ s,  $\delta$  < 2%

To evaluate the conduction losses, use the following equation:

$$P = 1.20 \times I_{F(AV)} + 0.225 \times I_{F}^{2}_{(RMS)}$$

For more information, please refer to the following application notes related to the power losses:

- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses on a power diode

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## Table 4. Dynamic characteristics ( $T_j$ = 25 °C unless otherwise stated)

Symbol	Parameters	Test conditions		Тур.	Max.	Unit
t <sub>rr</sub>	Reverse recovery time	$I_F = 0.5 \text{ A}, I_{rr} = 0.25 \text{ A}, I_R = 1 \text{ A}$	-	-	75	ns
t <sub>fr</sub>	Forward recovery time	$I_F = 1 \text{ A}, dI_F/dt = 50 \text{ A/}\mu\text{s}, V_{FR} = 1.1 \text{ V}_{F(max.)}$		-	300	ns
V <sub>FP</sub>	Forward recovery voltage			-	18	V

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#### 1.1 **Characteristics (curves)**

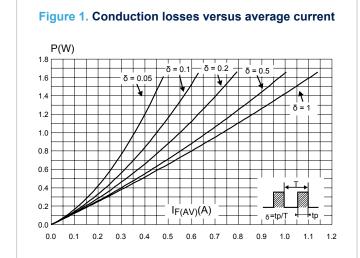
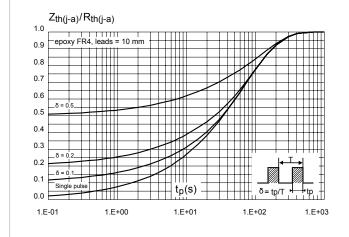
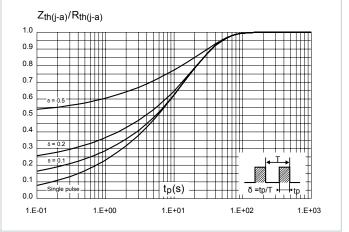


Figure 2. Forward voltage drop versus forward current (typical values) I<sub>FM</sub>(A) 100.0 10.0 1.0 V<sub>FM</sub>(V) 0.0 0.5 2.0 4.0

Figure 3. Relative variation of thermal impedance junction | Figure 4. Relative variation of thermal impedance junction to ambient versus pulse duration (DO-41)



to ambient versus pulse duration(SMA)



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Figure 5. Thermal resistance junction to ambient versus copper surface under each lead (DO-41)

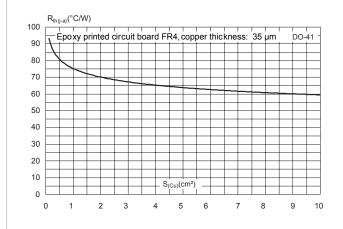
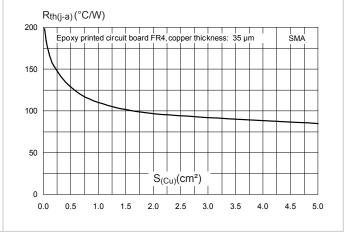


Figure 6. Thermal resistance junction to ambient versus copper surface under each lead (typical values) (SMA)



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## 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK is an ST trademark.

### 2.1 DO-41 package information

- Epoxy meets UL 94, V0
- · Band indicates cathode
- Bending method (DO-41): see Application note AN1471

Figure 7. DO-41 package outline

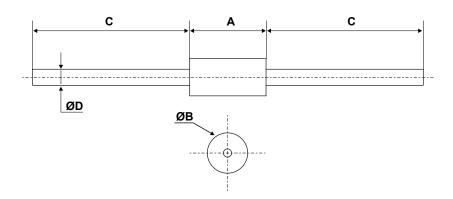


Table 5. DO-41 package mechanical data

	Dimensions						
Ref.	Millimeters			Inch	es (for reference	only)	
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α	4.07	-	5.20	0.160	-	0.205	
В	2.04	-	2.71	0.080	-	0.107	
С	25.40	-		1.000	-		
D	0.71	-	0.86	0.028	-	0.0034	

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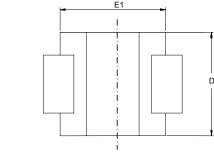


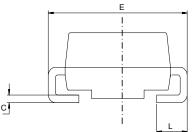
#### **SMA** package information 2.2

Epoxy meets UL94, V0

Cooling method : by conduction (C)







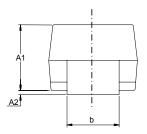


Table 6. SMA package mechanical data

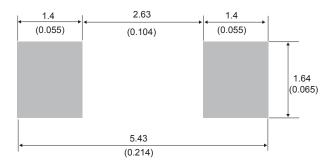
Figure 8. SMA package outline

	Dimensions					
Ref.	Millin	neters	Inches (for reference only)			
	Min.	Max.	Min.	Max.		
A1	1.90	2.45	0.074	0.097		
A2	0.05	0.20	0.001	0.008		
b	1.25	1.65	0.049	0.065		
С	0.15	0.40	0.005	0.016		
D	2.25	2.90	0.088	0.115		
E	4.80	5.35	0.188	0.211		
E1	3.95	4.60	0.155	0.182		
L	0.75	1.50	0.029	0.060		

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Figure 9. SMA recommended footprint in mm (inches)



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# 3 Ordering information

**Table 7. Ordering information** 

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STTH110	STTH110	DO-41	0.34 g	2000	Ammopack
STTH110A	H10	SMA	0.068 g	5000	Tape and reel 13"
STTH110RL	STTH110	DO-41	0.34 g	5000	Tape and reel 13"

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## **Revision history**

**Table 8. Document revision history** 

Date	Revision	Changes
Jan-2003	1	Initial release.
30-Sept-2009	2	Updated Table 8.
20-Dec-2013	3	Updated Table 4.
11-Dec-2019	4	Updated Table 3.

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